



Zeners 1N957B - 1N991B

Absolute Maximum Ratings *

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
P_D	Power Dissipation @ $TL \leq 75^\circ\text{C}$, Lead Length = 3/8"	500	mW
	Derate above 75°C	4.0	mW/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-65 to +200	$^\circ\text{C}$

* These ratings are limiting values above which the serviceability of the diode may be impaired.

Tolerance = 5%



Electrical Characteristics $T_A=25^\circ\text{C}$ unless otherwise noted

Device	V _Z (Volts) (Note 1)				Z _Z (Ω) (Note 2)		I _R @ V _R		I _{ZM} (mA) (Note 3)	
	Min.	Typ.	Max.	@ I _Z (mA)	Z _Z @ I _Z	Z _{ZK} @ I _{ZK}				
						Ω	mA			
1N957B	6.46	6.8	7.14	18.5	4.5	700	1.0	150	5.2	47
1N958B	7.125	7.5	7.875	16.5	5.5	700	0.5	75	5.7	42
1N959B	7.79	8.2	8.61	15	6.5	700	0.5	50	6.2	38
1N960B	8.645	9.1	9.555	14	7.5	700	0.5	25	6.9	35
1N961B	9.5	10	10.5	12.5	8.5	700	0.25	10	7.6	32
1N962B	10.45	11	11.55	11.5	9.5	700	0.25	5	8.4	28
1N963B	11.4	12	12.6	10.5	11.5	700	0.25	5	9.1	26
1N964B	12.35	13	13.65	9.5	13	700	0.25	5	9.9	24
1N965B	14.25	15	15.75	8.5	16	700	0.25	5	11.4	21
1N966B	15.2	16	16.8	7.8	17	700	0.25	5	12.2	19
1N967B	17.1	18	18.9	7.0	21	750	0.25	5	13.7	17
1N968B	19	20	21	6.2	25	750	0.25	5	15.2	15
1N969B	20.9	22	23.1	5.6	29	750	0.25	5	16.7	14
1N970B	22.8	24	25.2	5.2	33	750	0.25	5	18.2	13
1N971B	25.652	27	28.35	4.6	41	750	0.25	5	20.6	11
1N972B	8.5	30	31.5	4.2	49	1000	0.25	5	22.8	10
1N973B	31.35	33	34.65	3.8	58	1000	0.25	5	25.1	9.2
1N974B	34.2	36	37.8	3.4	70	1000	0.25	5	27.4	8.5
1N975B	37.05	39	40.95	3.2	80	1000	0.25	5	29.7	7.8
1N976B	40.85	43	45.15	3.0	93	1500	0.25	5	32.7	7.0
1N977B	44.65	47	49.35	2.7	105	1500	0.25	5	35.8	6.4
1N978B	48.45	51	53.55	2.5	125	1500	0.25	5	38.8	5.9
1N979B	53.2	56	58.8	2.2	150	2000	0.25	5	42.6	5.4
1N980B	58.9	62	65.1	2.0	185	2000	0.25	5	47.1	4.9
1N981B	64.6	68	71.4	1.8	230	2000	0.25	5	51.7	4.5

Electrical Characteristics (Continued) $T_A=25^\circ\text{C}$ unless otherwise noted

Device	V _Z (Volts) (Note 1)				Z _Z (Ω) (Note 2)		I _R @ V _R		I _{ZM} (mA) (Note 3)	
	Min.	Typ.	Max.	@ I _Z	Z _Z @ I _Z	Z _{ZK} @ I _{ZK}		μA	Volts	
						Ω	mA			
1N982B	71.25	75	78.75	1.7	270	2000	0.25	5	56.0	4.1
1N983B	77.9	82	86.1	1.5	330	3000	0.25	5	62.2	3.7
1N984B	86.45	91	95.55	1.4	400	3000	0.25	5	69.2	3.3
1N985B	95	100	105	1.3	500	3000	0.25	5	76.0	3.0
1N986B	104.5	110	115.5	1.1	750	4000	0.25	5	83.6	2.7
1N987B	114	120	126	1.0	900	4500	0.25	5	91.2	2.5
1N988B	123.5	130	136.5	0.95	1100	5000	0.25	5	98.8	2.3
1N989B	142.5	150	157.5	0.85	1500	6000	0.25	5	114	2.0
1N990B	152	160	168	0.80	1700	6500	0.25	5	121.6	1.9
1N991B	171	180	189	0.68	2200	7100	0.25	5	136.8	1.7

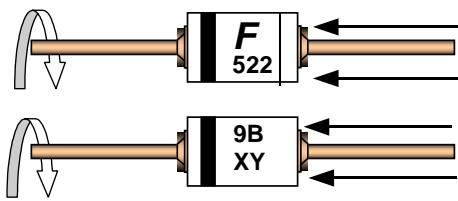
Notes:

1. Zener Voltage (V_Z) Measurement
Nominal zener voltage is measured with the device junction in the thermal equilibrium at the lead temperature (T_L) at $30^\circ\text{C} \pm 1^\circ\text{C}$ and 3/8" lead length.
2. Zener Impedance (Z_Z) Derivation
 Z_{ZT} and Z_{ZK} are measured by dividing the ac voltage drop across the device by the ac current applied. The specified limits are for I_{Z(ac)} = 0.1 I_{Z(dc)} with the ac frequency = 60Hz.
3. Maximum Zener Current Ratings (I_{ZM})
The maximum current handling capability on a worst case basis is limited by the actual zener voltage at the operation point and the power derating curve.

Top Mark Information

Device	Line 1	Line 2	Line 3	Line 4
1N957B	LOGO	957	B	XY
1N958B	LOGO	958	B	XY
1N959B	LOGO	959	B	XY
1N960B	LOGO	960	B	XY
1N961B	LOGO	961	B	XY
1N962B	LOGO	962	B	XY
1N963B	LOGO	963	B	XY
1N964B	LOGO	964	B	XY
1N965B	LOGO	965	B	XY
1N966B	LOGO	966	B	XY
1N967B	LOGO	967	B	XY
1N968B	LOGO	968	B	XY
1N969B	LOGO	969	B	XY
1N970B	LOGO	970	B	XY
1N971B	LOGO	971	B	XY
1N972B	LOGO	972	B	XY
1N973B	LOGO	973	B	XY
1N974B	LOGO	974	B	XY
1N975B	LOGO	975	B	XY
1N976B	LOGO	976	B	XY
1N977B	LOGO	977	B	XY
1N978B	LOGO	978	B	XY
1N979B	LOGO	979	B	XY
1N980B	LOGO	980	B	XY
1N981B	LOGO	981	B	XY
1N982B	LOGO	982	B	XY
1N983B	LOGO	983	B	XY
1N984B	LOGO	984	B	XY
1N985B	LOGO	985	B	XY
1N986B	LOGO	986	B	XY
1N987B	LOGO	987	B	XY
1N988B	LOGO	988	B	XY
1N989B	LOGO	989	B	XY
1N990B	LOGO	990	B	XY
1N991B	LOGO	991	B	XY

Top Mark Information (Continued)



1st line: F - Fairchild Logo
2nd line: Device Name - 3rd to 5th characters of the device name.
or 4th to 6th characters for BZxy series
3rd line: Device Name - 6th to 7th characters of the device name.
or Voltage rating for BZxy series
4th line: Device Code or - Two Digit - Six Weeks Date Code.
Date code plus or Two Digit - Six Weeks Date Code
Large die identification plus Large die identification, "L"

General Requirements:

- 1.0 Cathod Band
- 2.0 First Line: F - Fairchild Logo
- 3.0 Second Line: Device name - For 1Nxx series: 3rd to 5th characters of the device name.
For BZxx series: 4th to 6th characters of the device name.
- 4.0 Third Line: Device name - For 1Nxx series: 6th to 7th characters of the device name.
For BZxy series: Voltage rating
- 5.0 Fourth Line: XY or XYL - Two Digit - Six Weeks Date Code
Where: X represents the last digit of the calendar year
Y represents the Six weeks numeric code
L represents the Large die identification
- 6.0 Devices shall be marked as required in the device specification (PID or FSC Test Spec).
- 7.0 Maximum no. of marking lines: 4
- 8.0 Maximum no. of digits per line: 3
- 9.0 FSC logo must be 20 % taller than the alphanumeric marking and should occupy the 2 characters of the specified line.
- 10.0 Marking Font: Arial (Except FSC Logo)
- 11.0 First character of each marking line must be aligned vertically

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACE TM	FACT Quiet Series TM	ImpliedDisconnect TM	PACMAN TM	SPM TM
ActiveArray TM	FAST [®]	ISOPLANAR TM	POP TM	Stealth TM
Bottomless TM	FASTr TM	LittleFET TM	Power247 TM	SuperFET TM
CoolFET TM	FPS TM	MICROCOUPLER TM	PowerSaver TM	SuperSOT ^{TM-3}
CROSSVOLT TM	FRFET TM	MicroFET TM	PowerTrench [®]	SuperSOT ^{TM-6}
DOME TM	GlobalOptoisolator TM	MicroPak TM	QFET [®]	SuperSOT ^{TM-8}
EcoSPARK TM	GTO TM	MICROWIRE TM	QS TM	SyncFET TM
E ² CMOS TM	HiSeC TM	MSX TM	QT Optoelectronics TM	TinyLogic [®]
EnSigna TM	I ² C TM	MSXPro TM	Quiet Series TM	TINYOPTO TM
FACT TM	i-Lo TM	OCX TM	RapidConfigure TM	TruTranslation TM
Across the board. Around the world. TM		OCXPro TM	RapidConnect TM	UHC TM
The Power Franchise [®]		OPTOLOGIC [®]	SILENT SWITCHER [®]	UltraFET [®]
Programmable Active Droop TM		OPTOPLANAR TM	SMART START TM	VCX TM

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Fairchild Semiconductor](#):

[1N978B_T50R](#) [1N978B_T50A](#) [1N978B](#)